

WHAT IS CLAIMED IS:

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1. A floor polishing composition containing a film-formable organic high molecular material as the main component, which further contains at least scaly particles.
2. The floor polishing composition according to Claim 1, wherein the scaly particles are silica corresponding to layered polysilicic acid.
3. The floor polishing composition according to Claim 2, wherein the layered polysilicic acid is scaly silica particles having particle structures of layered structures present independently to each other, which comprises foliar silica secondary particles wherein a plurality of flaky primary particles of scaly silica are overlaid one on another and aligned face-to-face in parallel with one another.
4. The floor polishing composition according to Claim 2, wherein the foliar silica secondary particles composing the scaly silica are silica having the main peaks corresponding to silica-X and/or silica-Y according to X-ray diffraction analysis.
5. The floor polishing composition according to Claim 3, wherein the foliar silica secondary particles composing the scaly silica are silica having the main peaks corresponding to silica-X and/or silica-Y according to X-ray diffraction analysis.
6. The floor polishing composition according to Claim 1,
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material is provided on the floor polishing film.

20. A floor polishing film according to Claim 15, wherein an overcoating layer comprising an organic high molecular material is provided on the floor polishing film.

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